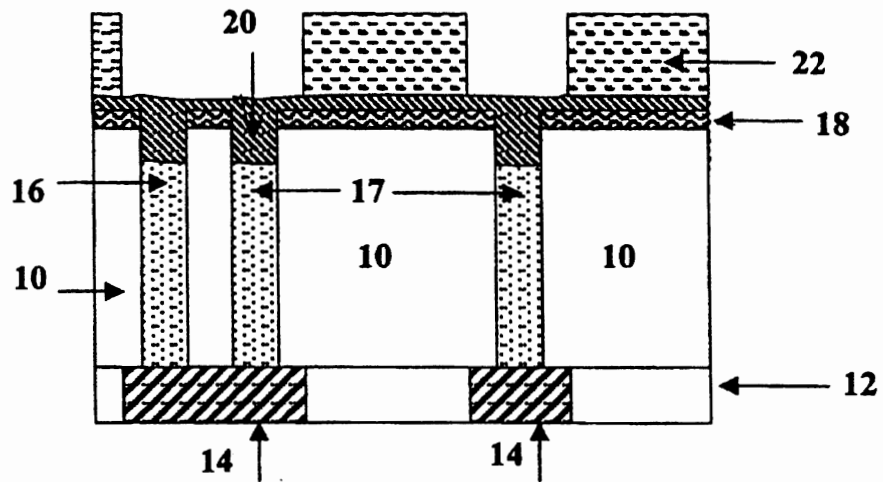
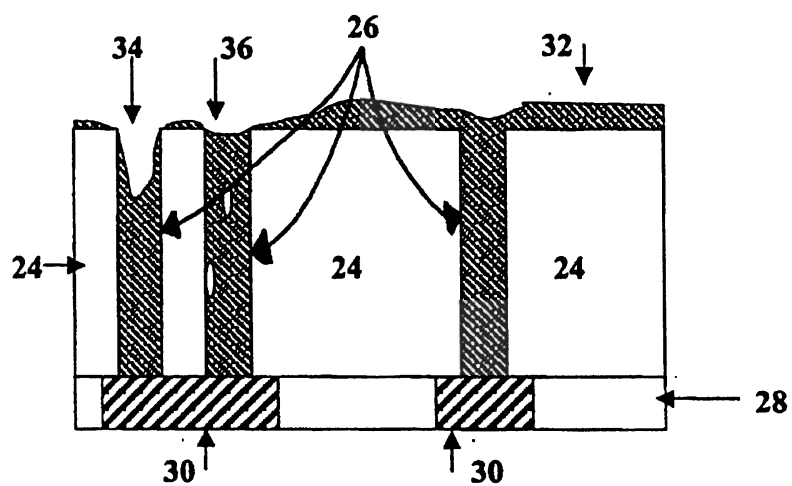
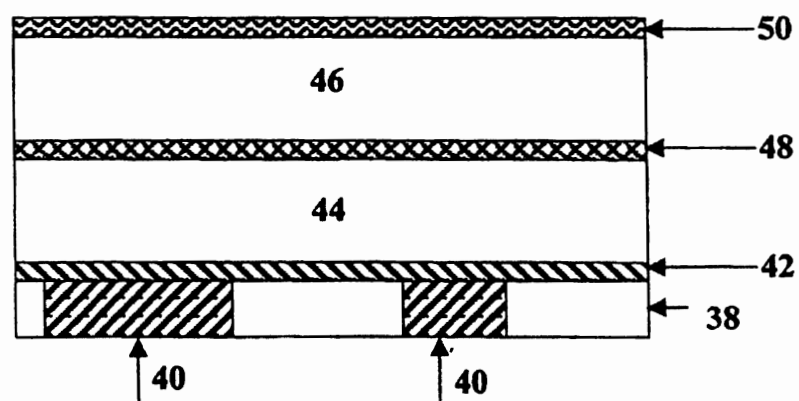


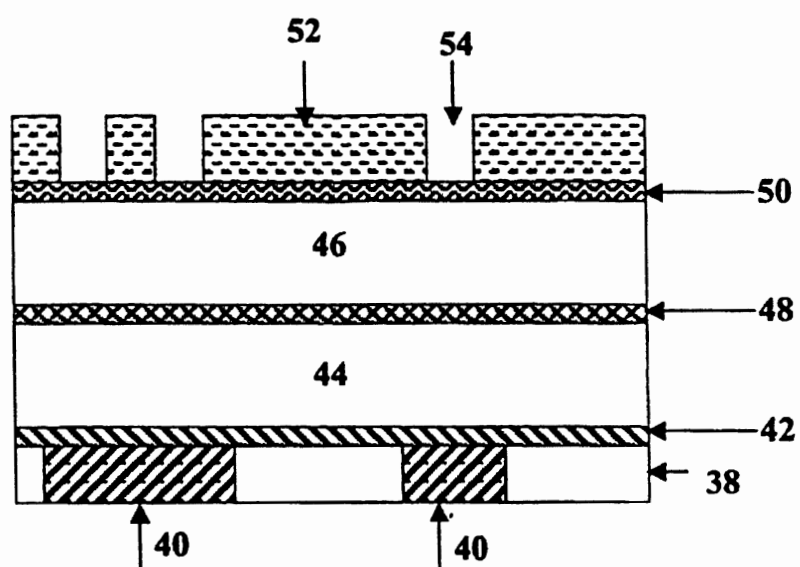


Prior Art
Fig. 1



Prior Art
Fig. 2

**Fig. 3a**

**Fig. 3b**

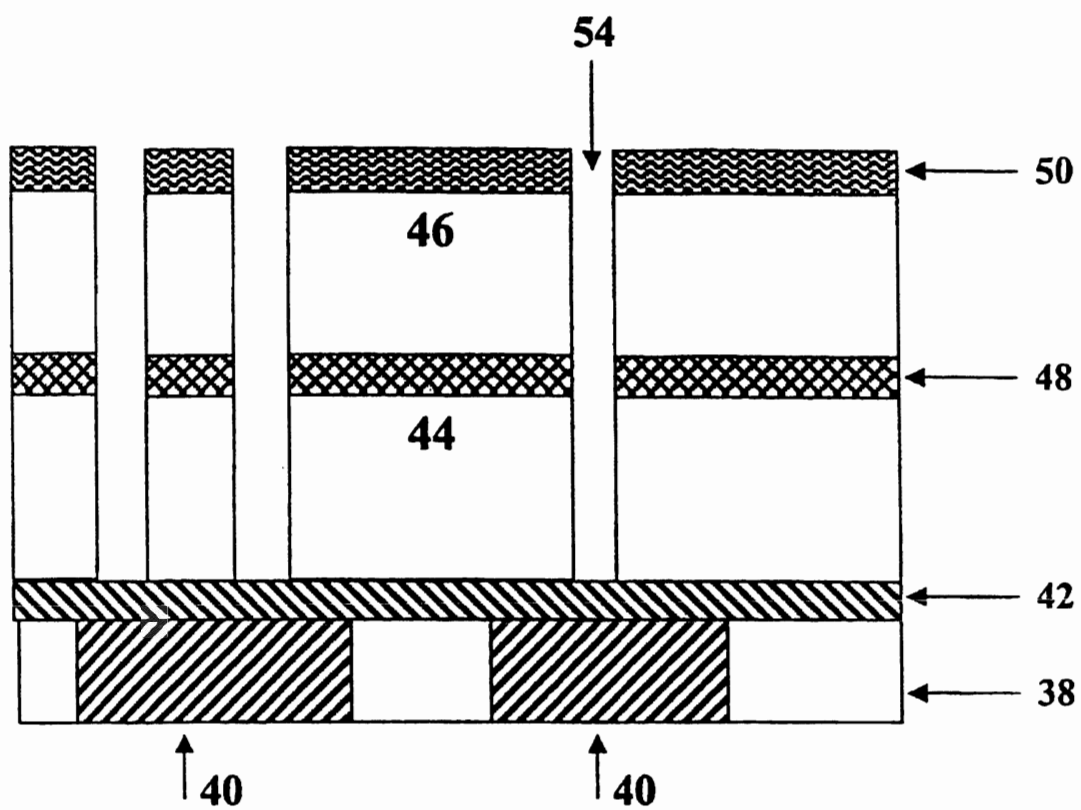
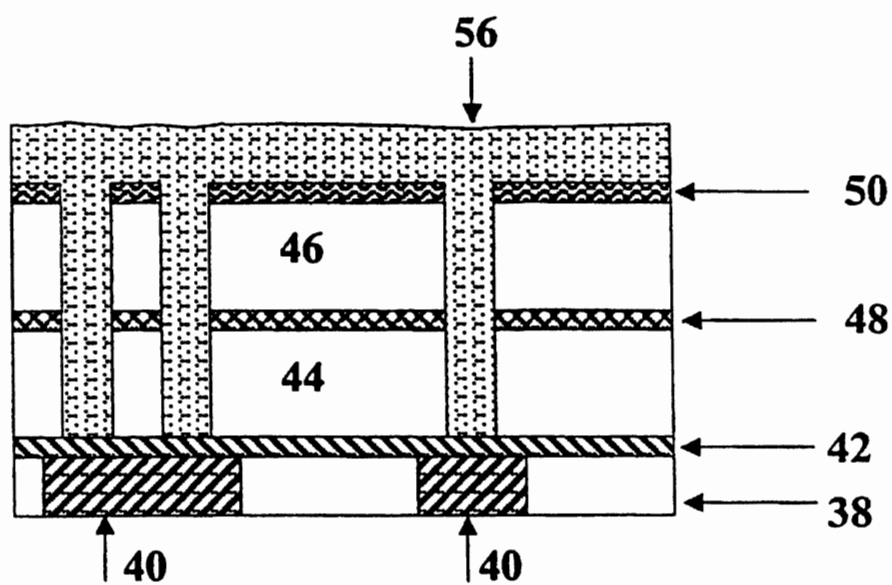


Fig. 3c

**Fig. 3d**

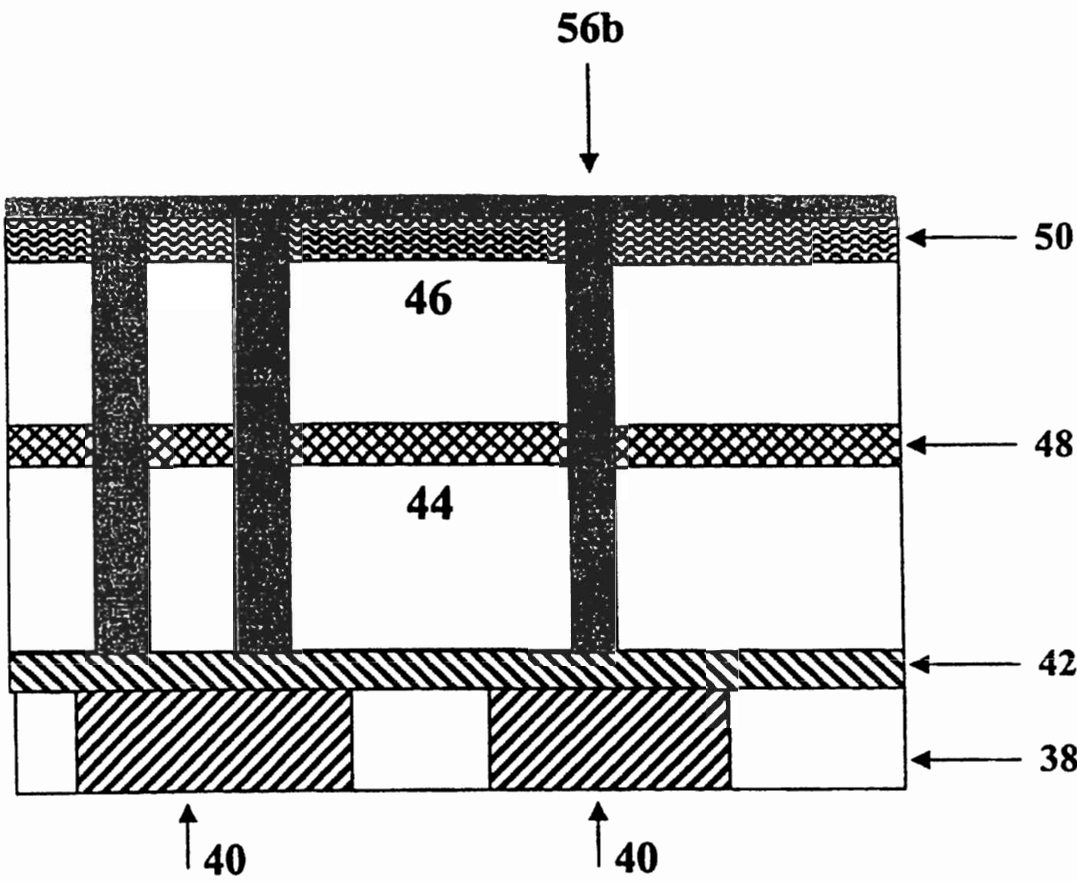


Fig. 3e

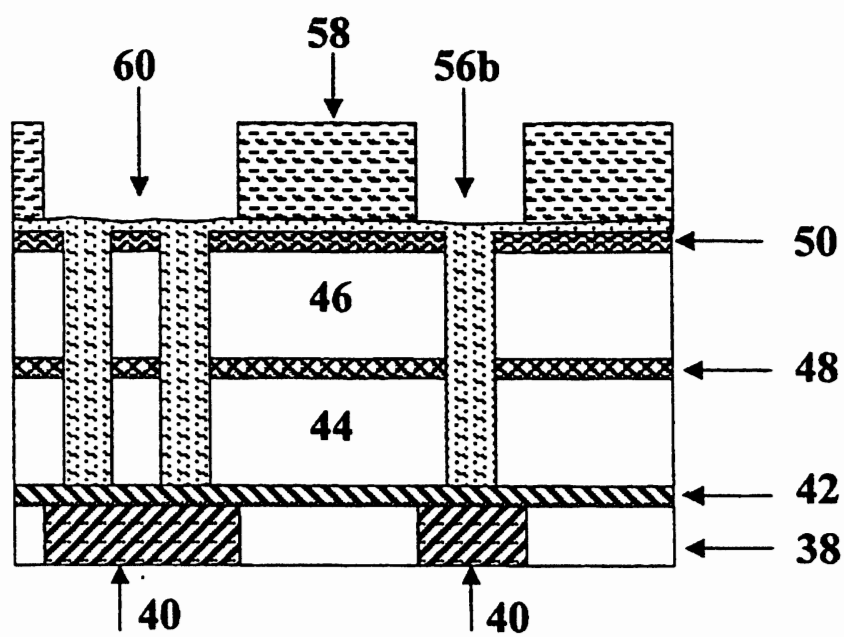
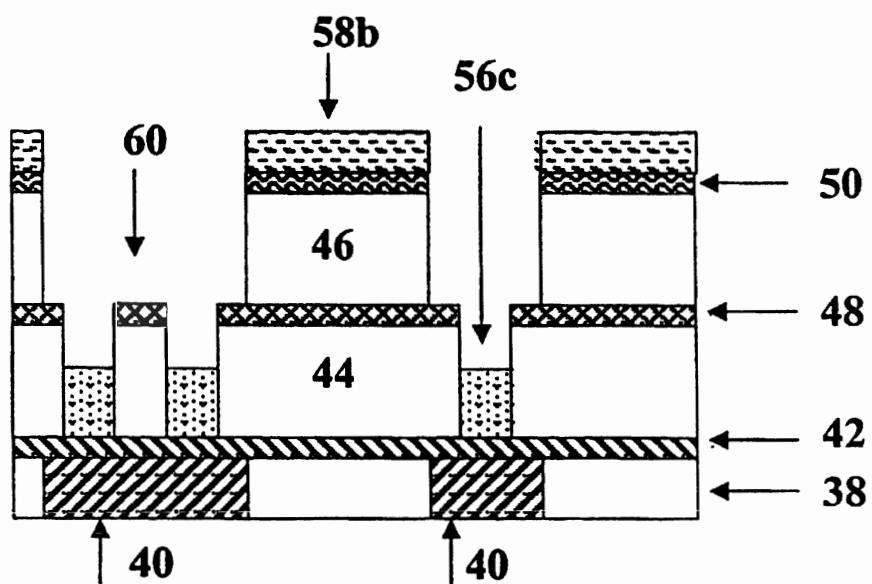
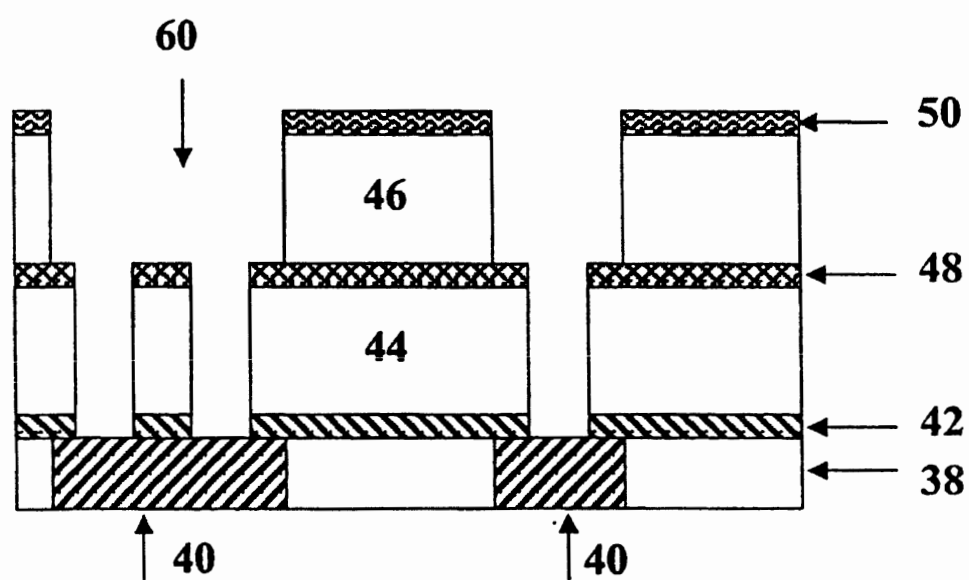
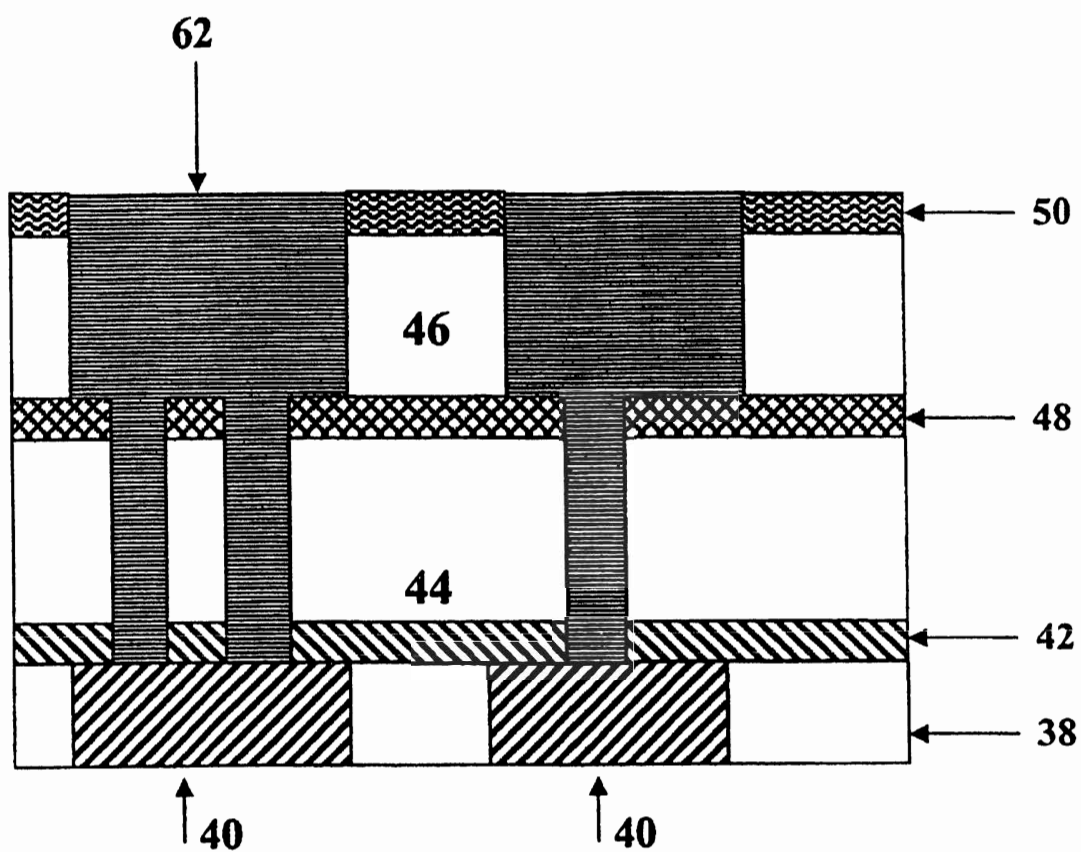


Fig. 3f

**Fig. 3g**

**Fig. 3h**

**Fig. 3i**

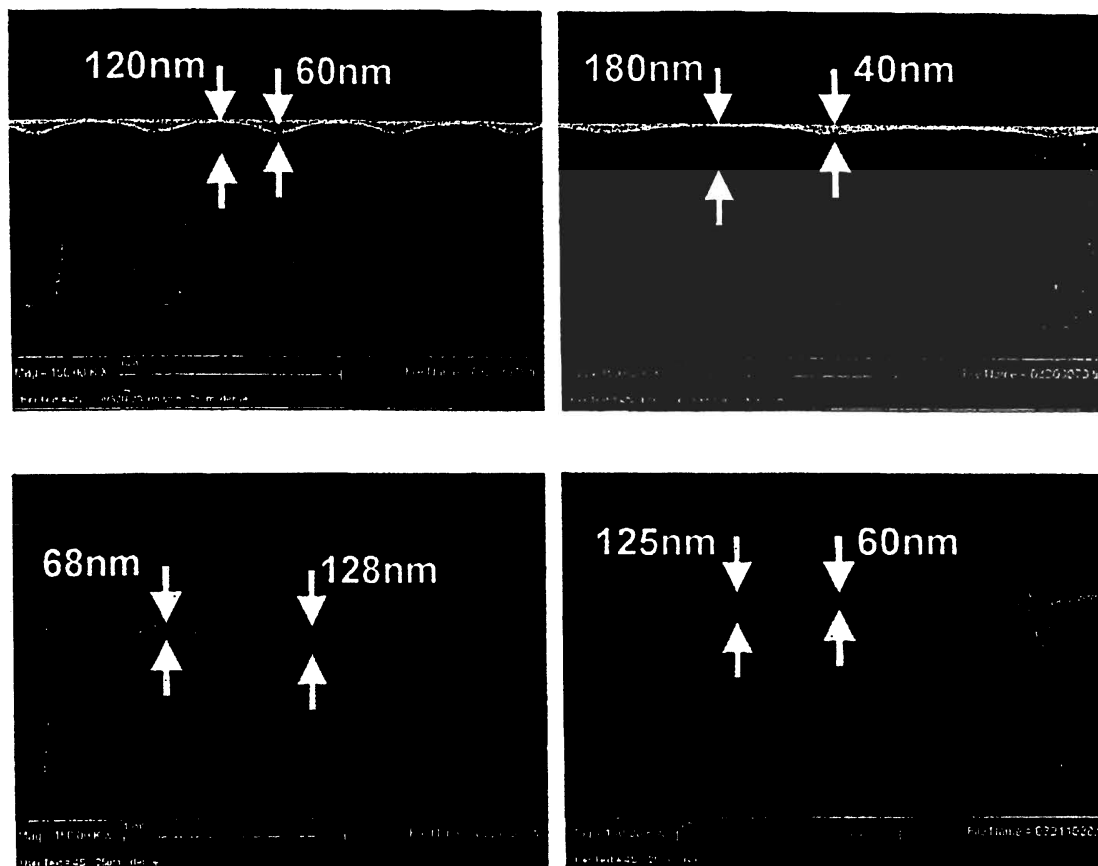
**Fig. 4**



Fig. 5
Prior Art

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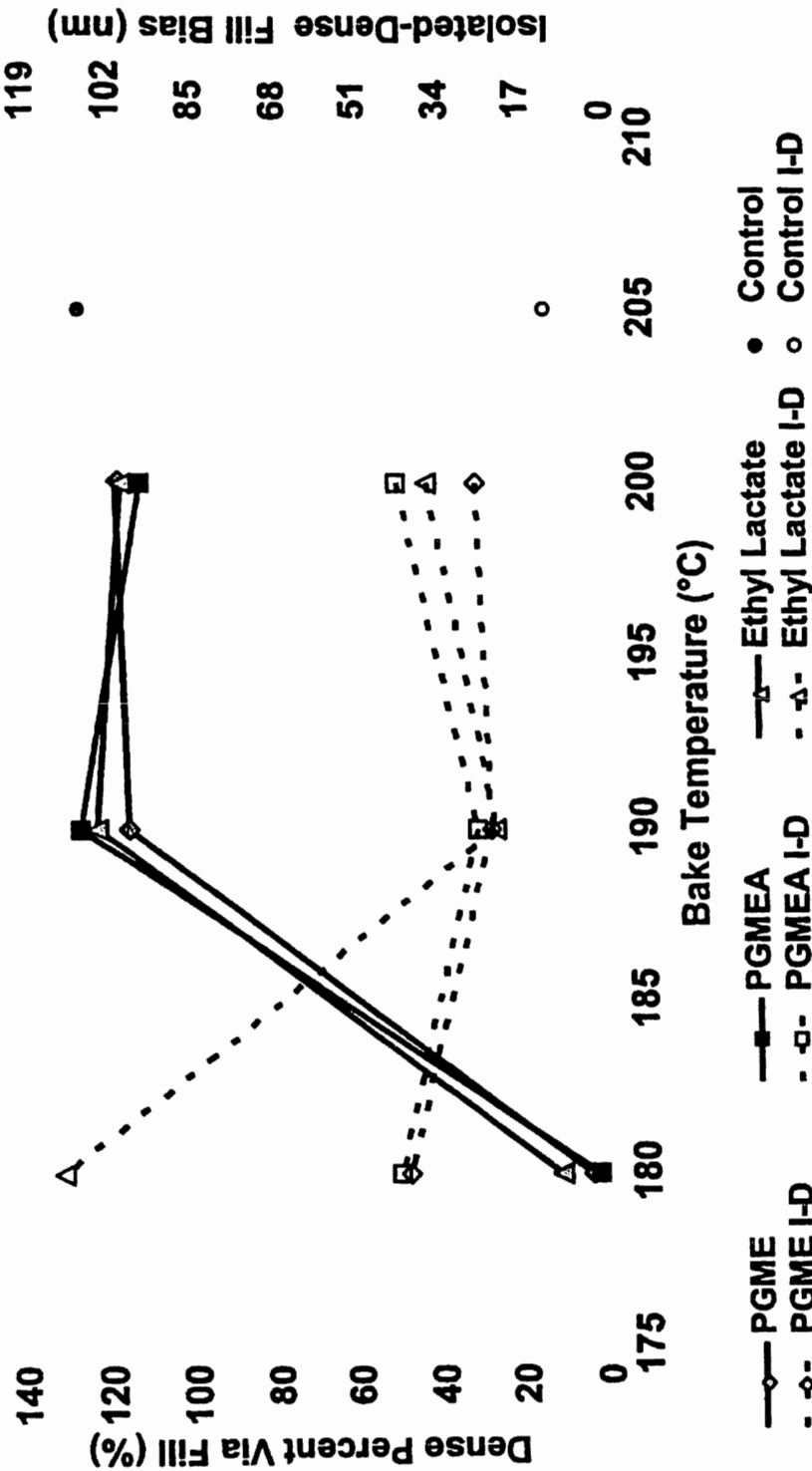


Fig. 6

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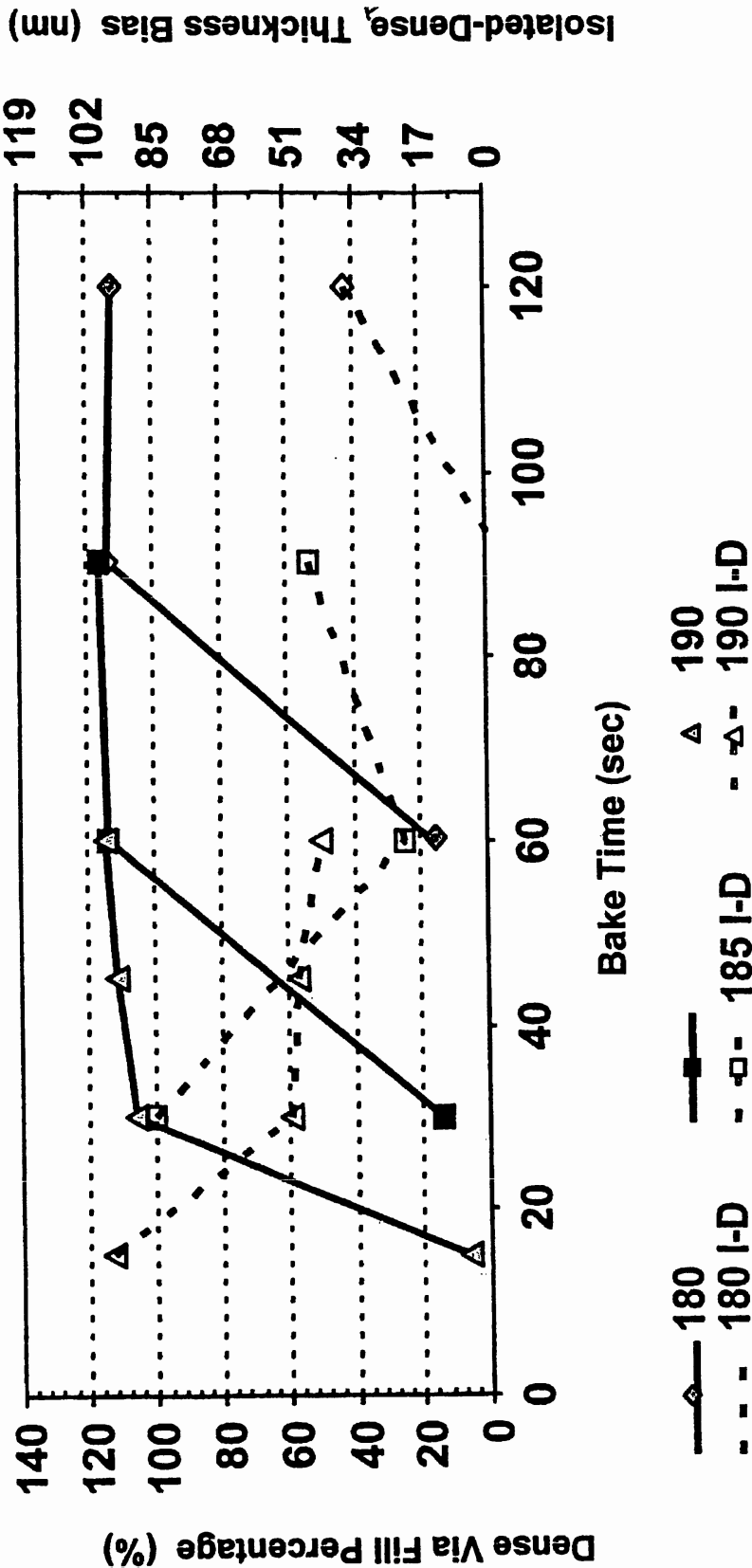


Fig. 7

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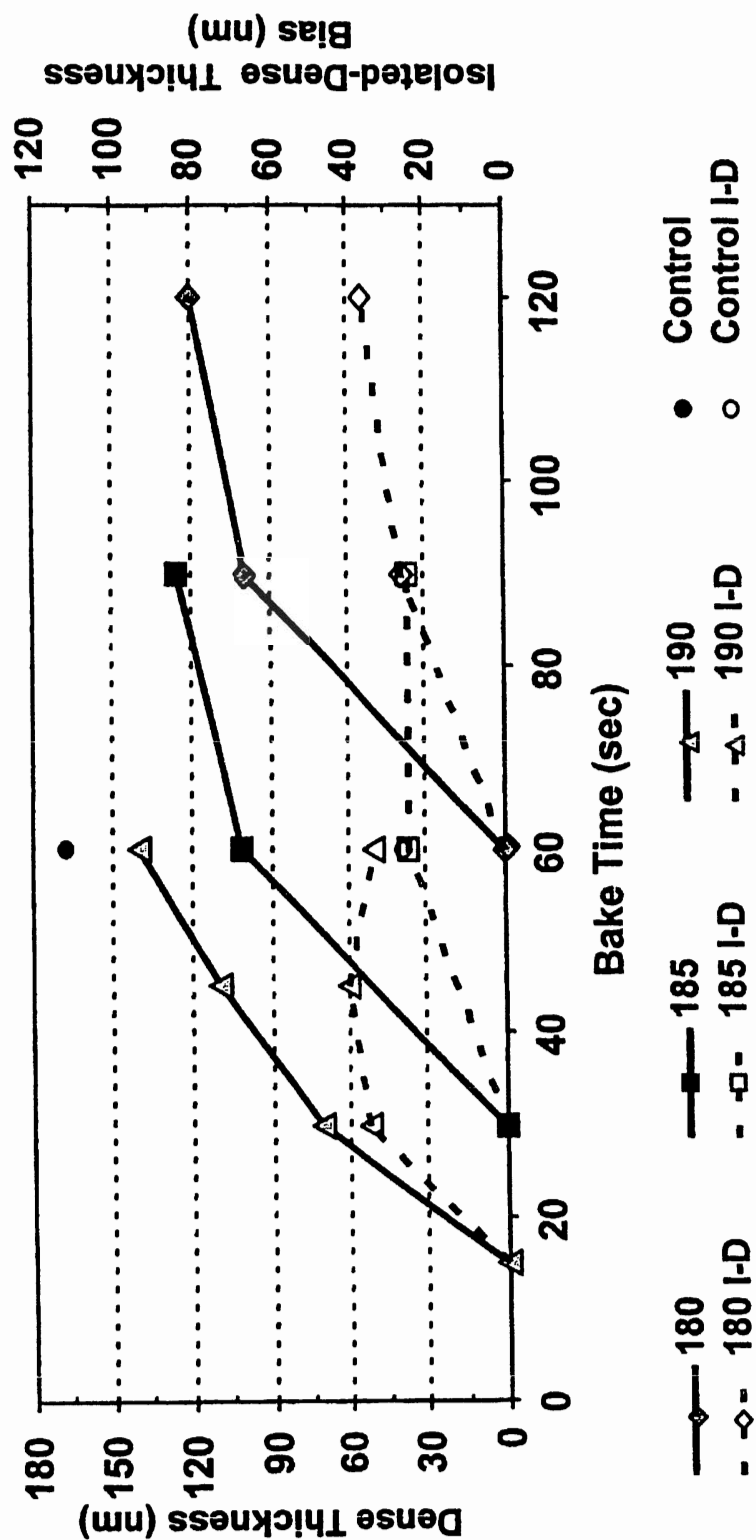


Fig. 8